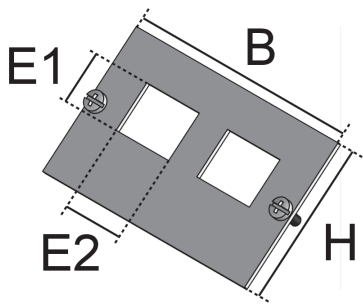


UDEP LEX

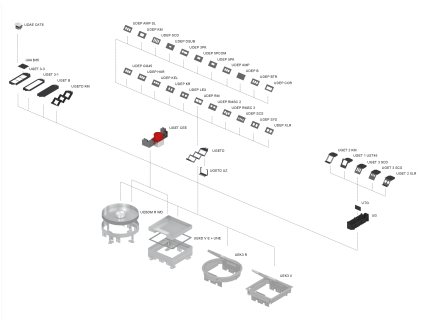
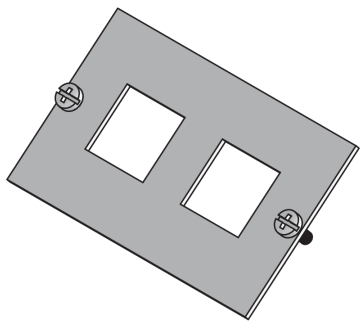
Mounting board, data technology



UDEP LEX components are installation boards from the underfloor system range. The boards are bolted into data device carriers and are used to accommodate up to 2 p D-Sub 9 connection sockets made by LexCom. The installation boards are made of aluminium with a black coating on one side and have the installation dimensions of E1 17.3 mm and E2 18.2 mm. A LexCom mounting frame must be used to mount the data jacks.

Artikel	Typ	H	B	data jacks	E1	E2	colour	W
UDEP-LEX 2	adapter board,	46 mm	75 mm	2	17.3 mm	18.2 mm	black	0.015 kg

DETAIL- UND ANWENDUNGSBILDER



OPTIONALES ZUBEHÖR

UGETD

